

SPECIFICATIONS FOR LCD **MODULE**

CUSTOMER	
MODEL	XRDZ-B00457AHUFGWSNN
CUSTOMER APPROVED	

APPROVED BY	CHECKED BY	ORGANIZED BY

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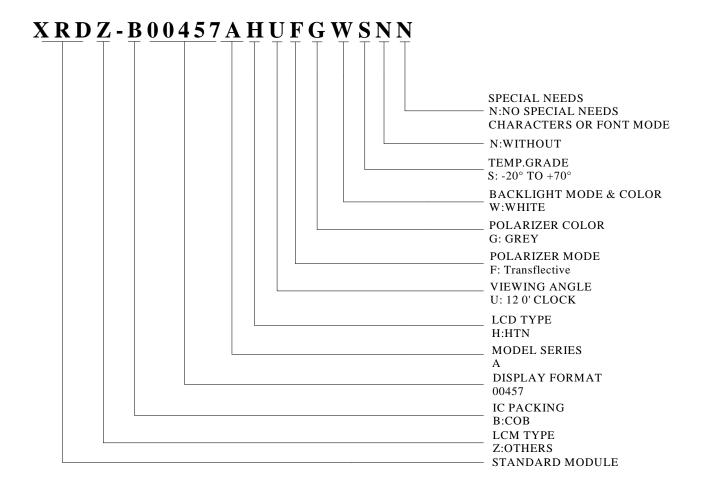
Specification Revision History

Version	Content	Date
A0	First Issue	03-Nov-2021
A1	修改 VDD 和数据信号为 3.3V	07-Dec-2021

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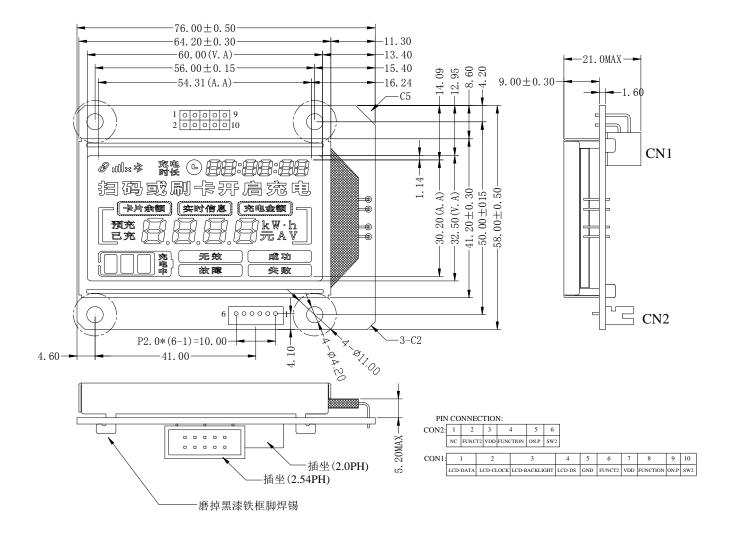
■ MODULE CLASSIFICATION INFORMATION



■ PHYSICAL DATA

ITEM	STANDARD VALUE	UNIT
NUMBER OF CHARACTERS		mm
MODULE DIMENSION	76.0×58.0×21.0(MAX)	mm
EFFECTIVE DISPLAY AREA	60.0×32.5	mm
CHARACTER SIZE	/	mm
CHARACTER PITCH	/	mm
LCD TYPE	HTN/POSITIVE(GREY)	
DUTY	1/4D, 1/3B	
VIEWING DIRECTION	12:00	o'clock
BACK LIGHT TYPE	SIDE LIT LED	
BACK LIGHT COLOR	White	
APPROX. WEIGHT	TBD	g

■ MECHANICAL DIMENSIONS



NOTES:

ALL UNMARKED TOLERANCES: ± 0.2 mm;

■ INTERFACE PIN CONNECTIONS

CON1:

NO	SYMBOL	LEVEL	FUNCTION
1	LCD-DATA	H/L	Serial data input/output.
2	LCD-CLOCK	H/L	WRITE clock input with pull-high resistor Data on the DATA line are latched into the CS1621 on the rising edge of the CLOCK signal.
3	LCD-BACKLIGHT	Н	Backlight Control
4	LCD-DS	L	Chip selection input with pull-high resistor
5	GND	OV	Ground
6	FUNCT2		Connect CON2.2
7	VDD	+3.3V	Positive power supply
8	FUNCTION		Connect CON2.4
9	ON. P		Connect CON2.5
10	SW2		Connect CON2.6

CON2:

CO112.			
NO	SYMBOL	LEVEL	FUNCTION
1	NC		
2	FUNCT2		Connect CON1.6
3	VDD	+3.3V	Positive power supply
4	FUNCTION		Connect CON1.8
5	ON. P		Connect CON1.9
6	SW2		Connect CON1.10

■ ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	MIN	MAX	UNIT
Supply voltage for logic	VCC	-0.3	5.5	V
Input voltage	VI	-0.3	VDD+0.3	V
Operating temperature	TOP	-20	+70	°C
Storage temperature	TST	-30	+80	°C

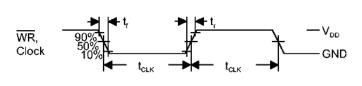
■ ELECTRICAL CHARACTERISTICS

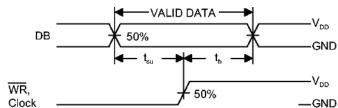
▼ DC Characteristics

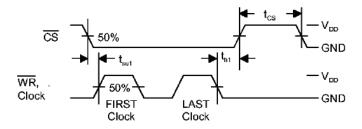
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Supply voltage for logic	VDD		3.1	3.3	3.5	V
Supply current for logic	IDD			150	300	μΑ
Input voltage 'H'level	VIH		2.4		3.5	V
Input voltage 'L' level	VIL		0		0.6	V

▼ AC Characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Unit
System Clock	fsys	On-chip RC oscillator		256		KHz
LCD Clock	flcd	On-chip RC oscillator		256/768		KHz
LCD Common Peried	tcom			4/ flcd		S
Serial interface reset	tcs	VDD=3.3V, /CS		250		ns
/WR Input pulse wide	tclk	VDD=3.3V,Write mode	3.34			us
Rise/Fall time serial DATA clock width	tr,tf	VDD=3.3V		120		ns
Setup time for DATA to /WR clock width	tsu	VDD=3.3V		120		ns
Hold time for DATA to /WR clock width	th	VDD=3.3V		120		ns
Setup time for /CS to /WR clock width	tsu1	VDD=3.3V		100		ns
Hold time for /CS to /WR clock width	th1	VDD=3.3V		100		ns



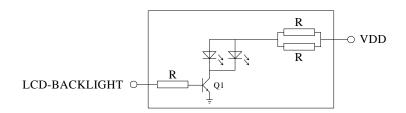




■ BACKLIGHT

▼ Backlight Type: LED▼ Backlight color: White

▼ Power Supply For Backlight



▼ Absolute Maximum Rating

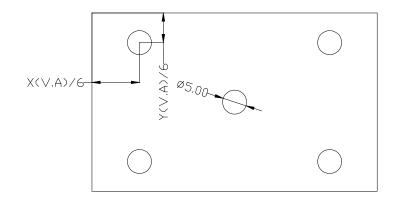
PARAMETER	SYMBOL	CONDITION	MAX	UNIT
Absolute maximum forward current	Ifm		60	mA
Peak forward current	Ifp	1 MSEC plus 10% Duty Cycle	80	mA
Reverse voltage	VR		5.0	V

Note: For operation above 25° C, Then Ifm Ifp must be decreased, the Current decreased is -1.08mA/°C for DC drive and -2.58mA/°C Pulse drive, the power dissipation is -4.5mW/°C. The product working current must not more than the 70% of the Ifm or Ifp according to the working temperature.

▼ Electrical-Optical Characteristics

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Forward voltage	Vf		3.1	3.3	3.5	V
Forward current	If			30	40	mA
Reverse current	Ir	VR=5.0V			10	μΑ
Chromoticity		If(forward aument) = 20m A	x=0.28	x=0.30	x=0.32	
Chromaticity		If(forward current) = 30mA	y=0.27	y=0.29	y=0.31	
Luminance	Lv	If(forward current) = 30mA				cd/m²

Note: The Master Screen's luminance is the average value of 5 points, and The Lvmin./Lvmax. is not less than 75%. The measurement instrument is BM-7 luminance Colorimeter. The aperture is Φ 5 mm.



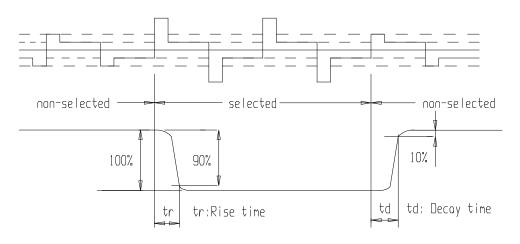
■ OPTICAL CHARACTERISTICS

Test instrument is LCD-5000, made in Japan

Item	Symbol	Condition	Min	Тур	Max	Unit	Remarks	Note
Operating voltage	Vop	25℃	2.9	3.1	3.3	V		
Dagmanga tima	Tr			150	230	ms		1
Response time	Td			180	230	ms		1
Contrast ratio	Cr		3	5				2
Viewing angle	0	Cr≥3		20		deg	Ø=0°	3
range	θ	U1 <u>≤</u> 3		40		deg	Ø=180°	3

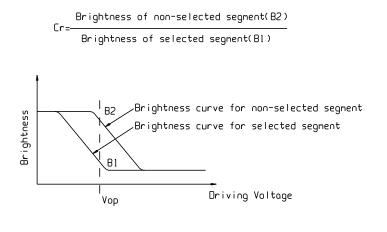
▼ Definition Of Viewing Angle

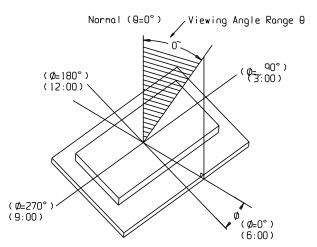
Note1: Definition of response time



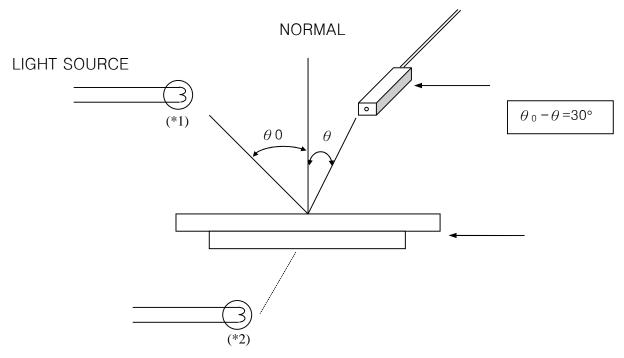
Note2: Definition of contrast ratio 'Cr'

Note3: Definition of viewing angle range ' θ '





Note4:Measuring Instruments For Electro-optical Characteristics



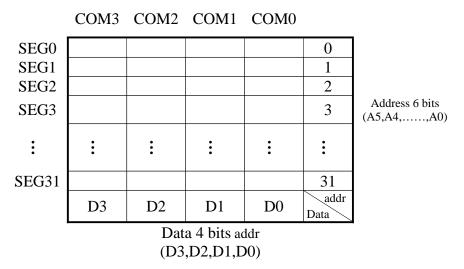
^{*1.}Light source position for measuring the reflective type of LCD panel

^{*2.}Light source position for measuring the transflective / transmissive types of LCD panel

■ OPERATING PRINCIPLES & METHODS

▼ Display memory-RAM

The static display memory (RAM) is organized into 32x4 bits and stores the displayed data. The contents of the RAM are directly mapped to the contents of the LCD driver. Data in the RAM can be accessed by the READ, WRITE, and READ-MODIFY-WRITE commands. The following is a mapping from the RAM to the LCD pattern:



RAM mapping

▼ System oscillator

The LCD OFF command is used to turn the LCD bias generator off. After the LCD bias generator switches off by issuing the LCD OFF command, using the SYS DIS command reduces power consumption, serving as a system power down command. At the initial system power on, the CS1621 is at the SYS DIS state.

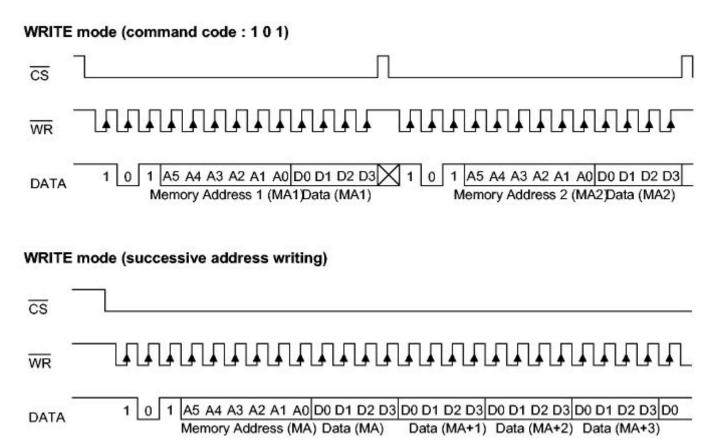
Command format

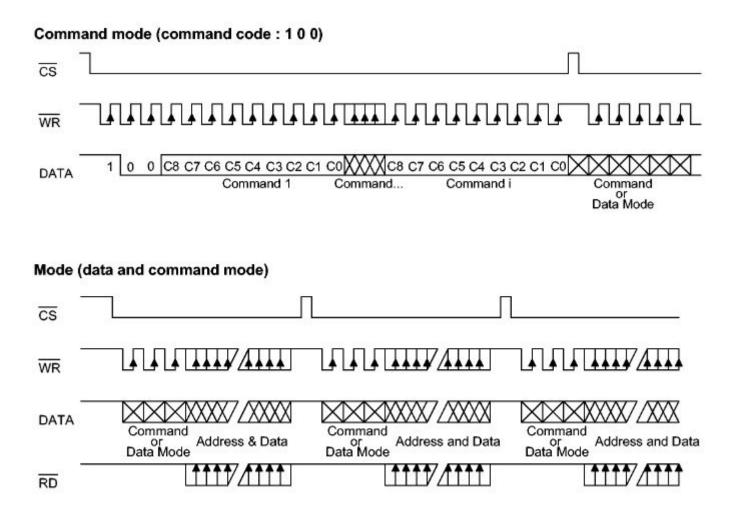
The CS1621 can be configured by the S/W setting. There are two mode commands to configure the CS1621 resources and to transfer the LCD display data. The configuration mode of the CS1621 is called command mode, and its command mode ID is 100. The command mode consists of a system configuration command, a system frequency selection command, a LCD configuration command, and an operating command. The data mode, on the other hand, includes WRITE operations. The following are the data mode IDs and the command mode ID:

Operation	Mode	ID
WRITE	Data	101
COMMAND	Command	100

The mode command should be issued before the data or command is transferred. If successive commands have been issued, the command mode ID, namely 100, can be omitted. While the system is operating in the non-successive command or the non-successive address data mode, the CS pin should be set to "1" and the previous operation mode will be reset also. Once the CS pin returns to "0" a new operation mode ID should be issued first.

▼ Timing Diagrams





Note: It is recommended that the host controller should read in the data from the DATA line between the rising edge of the \overline{RD} line and the falling edge of the next \overline{RD} line.

▼ Command Summary

Name	ID	Command Code	D/C	Function	Def.
WRITE	101	A5A4A3A2A1A0D0D1D2D3	D	Write data to the RAM	
SYS DIS	100	0000-0000-X	С	Turn off both system oscillator and LCD bias generator	Yes
SYS EN	100	0000-0001-X	C	Turn on system oscillator	
LCD OFF	100	0000-0010-X	C	Turn off LCD bias generator	Yes
LCD ON	100	0000-0011-X	C	Turn on LCD bias generator	
TIMER DIS	100	0000-0100-X	C	Disable time base output	
TIMER EN	100	0000-0110-X	С	Enable time base output	
CLR TIMER	100	0000-11XX-X	С	Clear the contents of time base generator	
RC 256K	100	0001-10XX-X	С	System clock source, on-chip RC oscillator	Yes
BIAS 1/2	100	0010-abX0-X	С	LCD 1/2 bias option ab=00:2 commons option ab=01:3 commons option ab=10:4 commons option	
BIAS 1/3	100	0010-abXl-X	С	LCD 1/3 bias option ab=00:2 commons option ab=01:3 commons option ab=10:4 commons option	
NORMAL	100	1110-0011-X	С	Normal mode	Yes

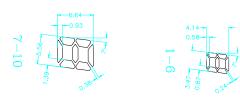
Note: X: Don't care

A5~A0 : RAM addresses D3~D0 : RAM data

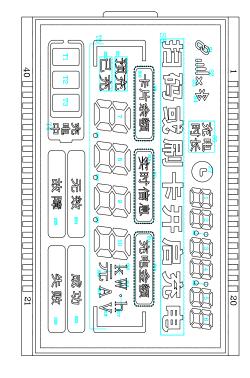
D/C : Data/command mode Def. : Power on reset default

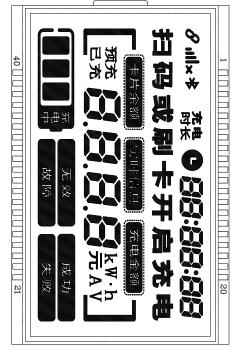
All the bold forms, namely 101, and 100, are mode commands. Of these, 100 indicates the Command mode ID. If successive commands have been issued, the command mode ID except for the first command will be omitted.

■ DISPLAY DATA RAM ADDRESS MAP



COM3	COM2	COM1	COMO	1	PIN		COM 3	COM2	COM1	COMO	1	PIN
ŀ	1	S17	S18	SEG16	21	COMO	SMO5		1	1	сомз	1
1	1	S16	S19	SEG17	22			COM2	ł	1	COM2	2
	1	S15	S20	SEG18	23				COM1	1	COM1	3
1	10B	106	10C	SEG19	24				ŀ	сомо	сомо	4
10A	10F	10E	10D	SEG20	25	C	82	S1	S2	S3	SEG0	5
9B	96	90	DP3	SEG21	26			S7	SS	S4	SEG1	6
9A	9F	9E	9D	SEG22	27			1E	16	1F	SEG2	7
8B	86	8C	DP2	SEG23	28	ō	10	10	1B	1A	SEG3	8
8	8F	8E	8D	SEG24	29			2E	2G	2F	SEG4	9
7B	7G	7C	DP1	SEG25	30	1	OC.	2C	2B	2A	SEG5	10
7A	7F	7E	7D	SEG26	31	000	COI 1	3E	3G	3F	SEG6	11
ŀ	1	S21	S22	SEG27	32	Ü	U.S.	3C	3B	3A	SEG7	12
1	1	S24	S23	SEG28	33			4E	4G	4F	SEG8	13
I	1	S25	S26	SEG29	34	ē	40	4C	4B	4A	SEG9	14
Т3	Τ4	-	1	SEG30	35	0	6 100	35	56	5F	SEG10	15
Т2	Τ1	!	!	SEG31	36	C	50	50	5B	5A	SEG11	16
1	1	!	COMO	COMO	37		1	39	66	6F	SEG12	17
I	1	COM1	1	COM1	38		GB.	96	6B	6A	SEG13	18
1	COM2	!	!	COM2	39	Ī	75	6S	S11	S13	SEG14	19
COM3	1	1	1	COM3	40			S10	S12	S14	SEG15	20

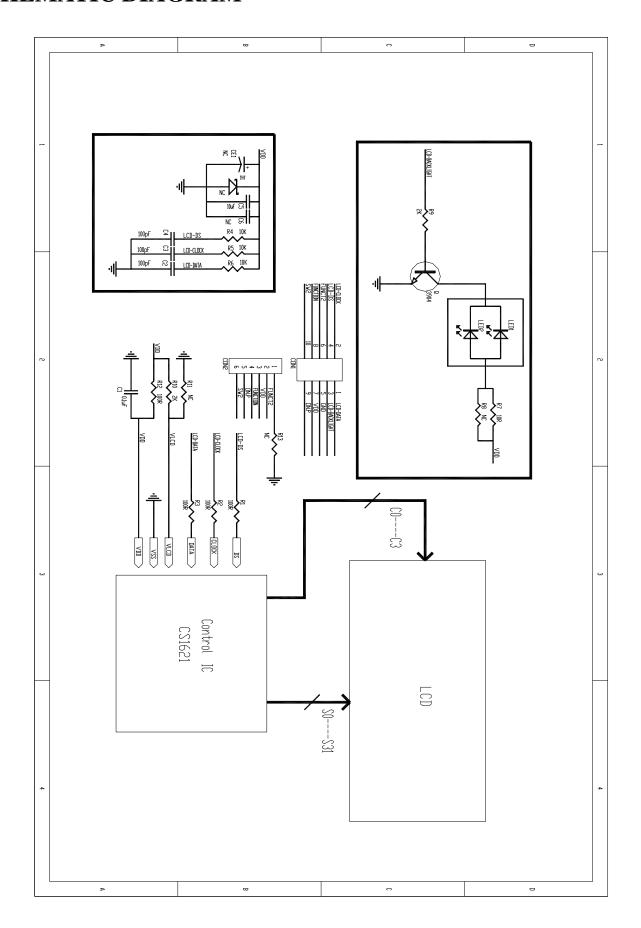




逻辑分段

CD显示效果图

■ SCHEMATIC DIAGRAM



■ RELIABILITY

▼ Content of Reliability Test

	Environmental Test									
No.	Test Item	Test Condition								
1	High temperature storage									
2	Low temperature storage	Endurance test applying the low storage temperature for a long time.	-30 °C 96hrs							
3	High temperature operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 96hrs							
4	Low temperature operation	Endurance test applying the electric stress under low temperature for a long time.	-20 °C 96hrs							
5	High temperature / Humidity storage	Endurance test applying the high tempera-ture and high humidity storage for a long time.	50°C, 90%RH 96hrs							
6	High temperature / Humidity operation	Endurance test applying the electric stress (Voltage & Current) and temperature / humidity stress to the element for a long time.	40°C 90%RH 96hrs							
7	Temperature cycle	Endurance test applying the low and high temperature cycle. $ \begin{array}{ccc} -20^{\circ}\text{C} & \longrightarrow & 25^{\circ}\text{C} & \longrightarrow & 70^{\circ}\text{C} \\ 30\text{min.} & \longrightarrow & 5\text{min.} & \longrightarrow & 30\text{min.} \\ \hline & 1 \text{ cycle} & & & & & & & & \\ \end{array} $	-20°C / 70°C 10 cycles							

^{***} Supply voltage for logic system = 3.3V. Supply voltage for LCD system = Operating voltage at 25°C.

▼ Failure Judgement Criterion

Criterion Item		Test Item No.						No.	,		Failure Judgment Criterion	
	1	2	3	4	5	6	7	8	9	10	11	
Basic specification												Out of the Basic Specification
Electrical characteristic												Out of the DC and AC Characteristic
Mechanical characteristic												Out of the Mechanical Specification Color change: Out of Limit Apperance Specification
Optical characteristic												Out of the Apperance Standard

■ INSPECTION CRITERIA

see :Q/XRD0002-05

■ PRECAUTIONS FOR USING LCD MODULES

▼ Handing Precautions

- (1) The display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol
- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents
- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

■ USING LCD MODULES

▼ Liquid Crystal Display Modules

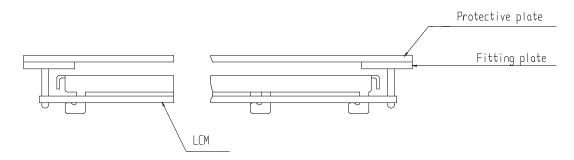
LCD is composed of glass and polarizer. Pay attention to the following items when handling.

- (1) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.
- (2) Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).
- (3) N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
- (4) When the display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.
- (5) Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
- (6) Avoid contacting oil and fats.
- (7) Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (8) Do not put or attach anything on the display area to avoid leaving marks on.
- (9) Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
- (10) As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

▼ Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

▼ Precaution for Handing LCD Modules

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- (1) Do not alter, modify or change the shape of the tab on the metal frame.
- (2) Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- (3) Do not damage or modify the pattern writing on the printed circuit board.
- (4) Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- (5) Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- (6) Do not drop, bend or twist LCM.

▼ Electro-Static Discharge Control

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

- (1) Make certain that you are grounded when handing LCM.
- (2) Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- (3) When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- (4) When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- (5) As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- (6) To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

▼ Precaution for soldering to the LCM

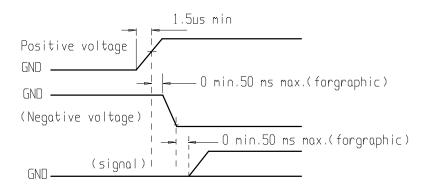
- (1) Observe the following when soldering lead wire, connector cable and etc. to the LCM.
 - Soldering iron temperature : $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$.
 - Soldering time : 3-4 sec.
 - Solder: eutectic solder.

If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage dur to flux spatters.

- (2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- (3) When remove the electoluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

▼ Precautions for Operation

- (1) Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
- (2) Driving the LCD in the voltage above the limit shortens its life.
- (3) Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- (4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- (5) Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C, 50% RH.
- (6) When turning the power on, input each signal after the positive/negative voltage becomes stable.



▼ Storage

When storing LCD's as spares for some years, the following precaution are necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)
- (4) Environmental conditions:
 - Do not leave them for more than 168hrs. at 70°C.
 - Should not be left for more than 48hrs. at -20°C.

Safety

- (1) It is recommended to crush damaged or unnecessary LCD's into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- (2) If any liquid leakes out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

▼ Limited Warranty

Unless agreed between X.R.D and customer, X.R.D will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with X.R.D LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to X.R.D within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of X.R.D limited to repair and/or replacement on the terms set forth above. X.R.D will not be responsible for any subsequent or consequential events.

▼ Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet's damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet's, conductors and terminals.